

12-BIT, 80 MSPS CommsADC™ ANALOG-TO-DIGITAL CONVERTER

FEATURES

- 80-MSPS Maximum Sample Rate
- 12-Bit Resolution
- No Missing Codes
- 360-mW Power Dissipation
- CMOS Technology
- On-Chip S/H
- 75 dB Spurious Free Dynamic Range at 100 MHz IF
- 1-GHz Bandwidth Differential Analog Input
- On-Chip References
- 2s Complement Digital Output
- 3.3-V Analog, 1.8-V Digital Supply
- 1.8 V–3.3 V I/O

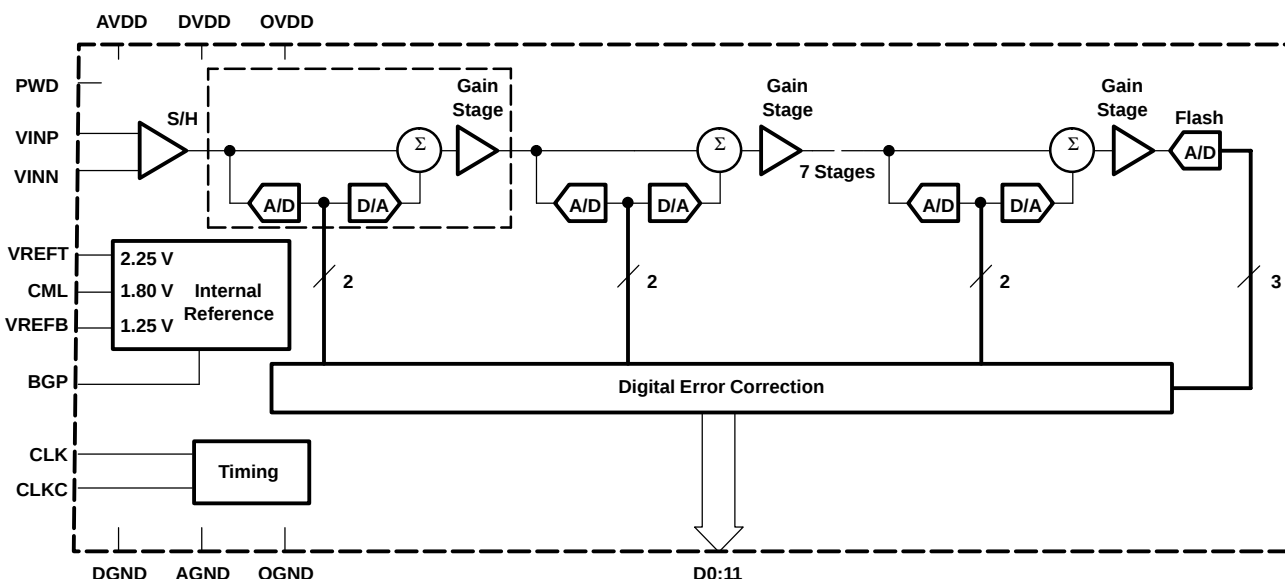
APPLICATIONS

- Cellular Base Transceiver Station Receive Channel
 - IF Sampling Applications
 - TDMA: GSM, IS-136, EDGE/UWC-136
 - CDMA: IS-95, UMTS, CDMA2000
 - Wireless Local Loop
 - LMDS, MMDS
 - Wideband Baseband Receivers
- Medical Imaging:
 - Ultrasound
 - Magnetic Resonant Imaging
- Portable Instrumentation

DESCRIPTION

The ADS5410 is a high-speed, high-performance pipelined analog-to-digital converter with exceptionally low-noise and high spurious-free dynamic range. The ADS5410 high input bandwidth makes it ideal for IF subsampling solutions where digital I/Q demodulators are used. Its high dynamic range makes it well suited for GSM, IS-95, UMTS, and IS-136 digital receivers. Its linearity and low DNL make it ideal for medical imaging applications. Low power consumption makes the ADS5410 ideal for applications in compact pico- and micro-base stations and in portable designs.

FUNCTIONAL BLOCK DIAGRAM



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

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AVAILABLE OPTIONS

T_A	PACKAGE
	48-TQFP
–40°C to 85°C	ADS5410IPFB



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

ABSOLUTE MAXIMUM RATINGS

over operating free-air temperature range unless otherwise noted⁽¹⁾

		ADS 5410
Supply voltage range	AVDD	–0.3 V to 4 V
	DVDD	–0.3 V to 2.3 V
	OVDD	–0.3 V to 3.6 V
Voltage between	AGND and DGND	–0.3 to 0.3 V
	AVDD to DVDD	–3.3 V to 3.3 V
Digital input ⁽²⁾		–0.3 V to AVDD + 0.3 V
Digital data output		–0.3 V to OVDD + 0.3 V
Clamp current for digital input or output		±20 mA
Operating free-air temperature range, T_A		–40°C to 85°C

⁽¹⁾ Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

⁽²⁾ Measured with respect to AGND.

RECOMMENDED OPERATING CONDITIONS

	MIN	NOM	MAX	UNIT
SUPPLIES AND REFERENCES				
Operating free-air temperature, T _A	−40		85	°C
Analog supply voltage, V _(AVDD)	3	3.3	3.6	V
Digital supply voltage, V _(DVDD)	1.6	1.8	2	V
ANALOG INPUTS				
Output driver supply voltage, V _(OVDD)	1.6		3.6	V
Input common-mode voltage	CML ⁽¹⁾			V
Differential input voltage range	2			V _{pp}
CLOCK INPUTS CLK AND CLKC				
Sample rate, f _(S)	5		80	MHz
Differential input mode voltage input swing	0.4		3.3	V
Differential input common mode voltage	1.65			V
Single-ended mode high-level input voltage, V _{IH(S)}	2			V
Single-ended mode low-level input voltage, V _{IL(S)}	0.8			V
Clock pulse width high, t _{w(H)}	5.625	6.25		ns
Clock pulse width low, t _{w(L)}	5.625	6.25		ns

⁽¹⁾ See references section in DC ELECTRICAL CHARACTERISTICS table.

DC ELECTRICAL CHARACTERISTICS

over operating free-air temperature range, clock frequency = 80 MSPS, 50% clock duty cycle (AVDD = 3.3 V, DVDD = 1.8 V, OVDD = 1.8 V) (unless otherwise noted)

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
DC Accuracy ⁽¹⁾						
No missing codes		Fs = 88 MSPS ⁽²⁾	Assured			
DNL	Differential nonlinearity		−0.9	±0.5	1	LSB
INL	Integral nonlinearity		−2	±1.5	2	LSB
EO	Offset error		3			mV
EG	Gain error		0.5			%FS
Power Supply						
I(AVDD)	Analog supply current	Fs = 80 MSPS, AI = FS, fi = 2 MHz	105			mA
I(DVDD)	Digital supply current		1			
I(OVDD)	Digital output driver supply current		3.5			
	Power dissipation		360	450	mW	
	Power down dissipation	PWDN = high	30	45	mW	
PSRR	Power supply rejection ratio		±0.3			mV/V
References						
Vref(VREFB)	Reference bottom		1.1	1.25	1.4	V
Vref(VREFT)	Reference top		2.1	2.25	2.4	V
	VREFT − VREFB		1.06			V
	VREFT − VREFB variation (6σ)		0.06			V
VOC(CML)	Common mode output voltage		1.8			V
Digital Inputs (PWD)						
IiH	High-level input current	Vi = 1.6 V	−10		10	μA
IiL	Low-level input current	Vi = 0.3 V	−10		10	μA
ViH	High-level input voltage		1.8			V
ViL	Low-level input voltage				0.8	V
Digital Outputs						
VOH	High-level output voltage	IOH = −50 μA	1.4			V
VOL	Low-level output voltage	IOL = 50 μA			0.4	V

(1) Fs = 80 MSPS, sinewave input, fi = 2 MHz

(2) Speed margin test

ADS5410

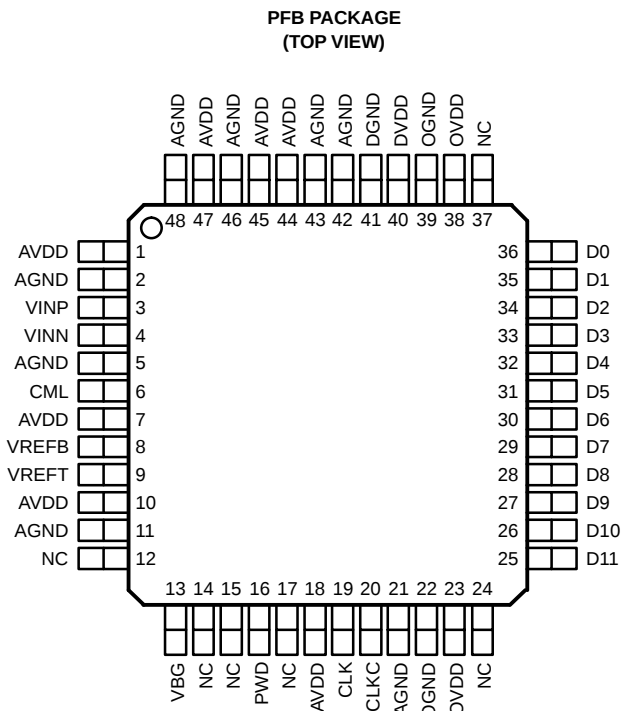
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AC ELECTRICAL CHARACTERISTICS

over operating free-air temperature range, clock frequency = 80 MSPS, 50% clock duty cycle (AVDD = 3.3 V, DVDD = 1.8 V, OVDD = 1.8 V) (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
SFDR Spurious free dynamic range, $A_i = -1$ dBFS (no exceptions)	$f_i = 2.2$ MHz		76		dBc
	$f_i = 17.4$ MHz	72	76		
	$f_i = 31$ MHz		76		
	$f_i = 70$ MHz		72		
	$f_i = 150$ MHz		70		
HD3 Third order harmonic, $A_i = -1$ dBFS	$f_i = 2.2$ MHz		84		dBc
	$f_i = 17.4$ MHz		84		
	$f_i = 31$ MHz		86		
	$f_i = 70$ MHz		79		
	$f_i = 150$ MHz		70		
HD2 Second order harmonic, $A_i = -1$ dBFS	$f_i = 2.2$ MHz		81		dBc
	$f_i = 17$ MHz		80		
	$f_i = 31$ MHz		90		
	$f_i = 70$ MHz		88		
	$f_i = 150$ MHz		75		
SNR Signal-to-noise ratio, $A_i = -1$ dBFS	$f_i = 2.2$ MHz		67		dB
	$f_i = 17.4$ MHz	63	66		
	$f_i = 31$ MHz		65		
	$f_i = 70$ MHz		62		
	$f_i = 150$ MHz		57		
SINAD Signal-to-noise and distortion, $A_i = -1$ dBFS	$f_i = 2.2$ MHz		66		dB
	$f_i = 17.4$ MHz	62.5	65		
	$f_i = 31$ MHz		64		
	$f_i = 70$ MHz		61		
	$f_i = 150$ MHz		56		
Two tone IMD rejection, $A_{1,2} = -7$ dBFS	$f_1 = 15.2$ MHz, $f_2 = 15.9$ MHz		77		dBc
Track mode bandwidth	-3 dB BW with -3dBFS input at low frequency		1		GHz

PIN ASSIGNMENTS



Terminal Functions

TERMINAL NAME	TERMINAL NO.	I/O	DESCRIPTION
AVDD	1, 7, 10, 18, 44, 45, 47	I	Analog power supply
AGND	2, 5, 11, 21, 42, 43, 46, 48	I	Analog ground
CLK	19	I	Clock input
CLKC	20	I	Complementary clock input
CML	6	O	Common-mode output voltage
D11–D0	25–36	O	Digital outputs, D11 is most significant data bit, D0 is least significant data bit.
DGND	41	I	Digital ground
DVDD	40	I	Digital power supply
NC	12, 14, 15, 17, 24, 37		No connection
OGND	22, 39	I	Digital driver ground
OVDD	23, 38	I	Digital driver power
PWD	16	I	Power down, active high
VBG	13	O	Bandgap voltage output
VINN	4	I	Complementary analog input
VINP	3	I	Analog input
VREFB	8	O	Reference bottom
VREFT	9	O	Reference top

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TIMING DIAGRAMS

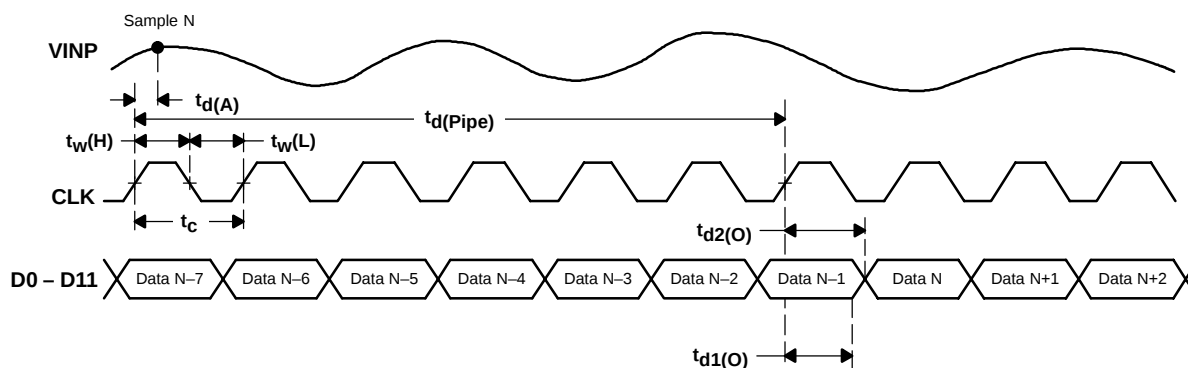


Figure 1. ADS5410 Timing Diagram

TIMING CHARACTERISTICS

		MIN	TYP	MAX	UNIT
$t_d(A)$	Aperture delay		2		ns
	Aperture jitter		1.5		ps
$t_{d1}(O)$	Output propagation delay (beginning of transition)		6		ns
$t_{d2}(O)$	Output propagation delay (data stable)		10		ns
$t_d(Pipe)$	Latency		6		Clock cycles

TYPICAL CHARACTERISTICS†

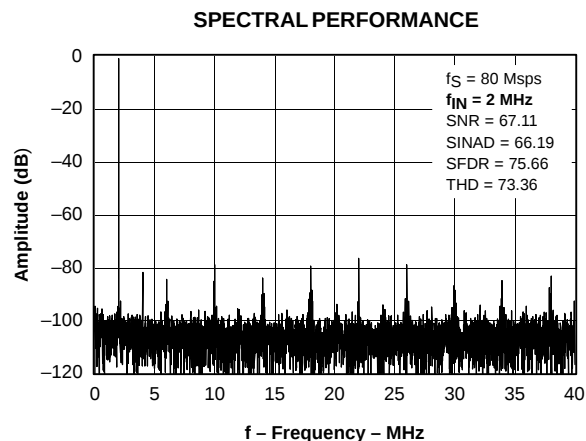


Figure 2

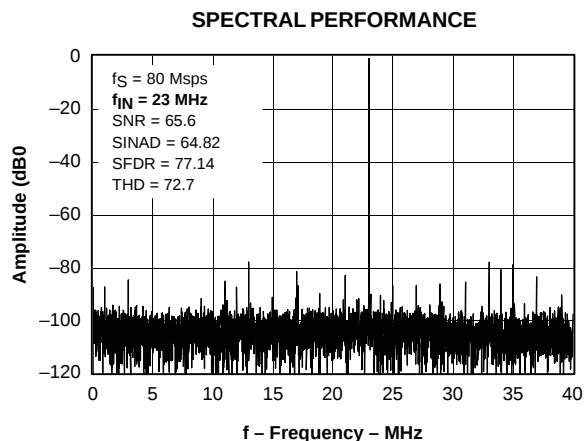


Figure 3

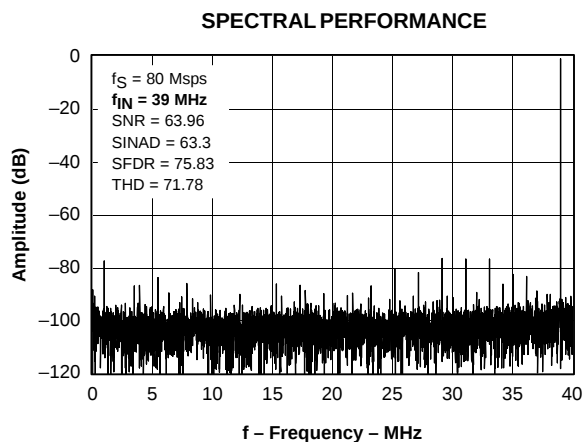


Figure 4

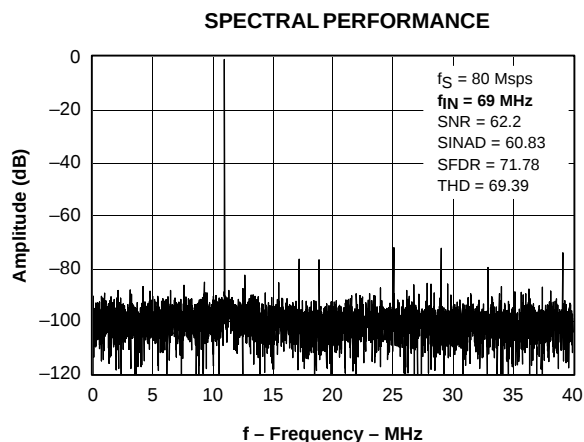


Figure 5

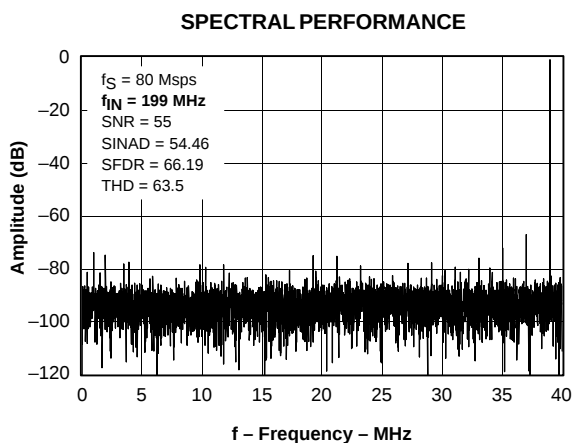


Figure 6

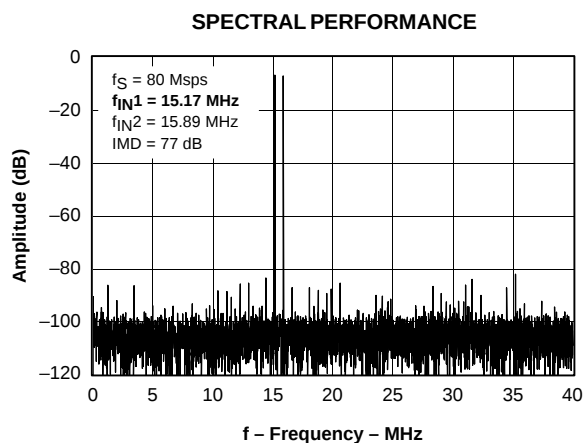


Figure 7

†50% duty cycle. $AV_{DD} = 3.3$ V, $DV_{DD} = 1.8$ V, $DV_{DD} = 1.8$ V

TYPICAL CHARACTERISTICS†

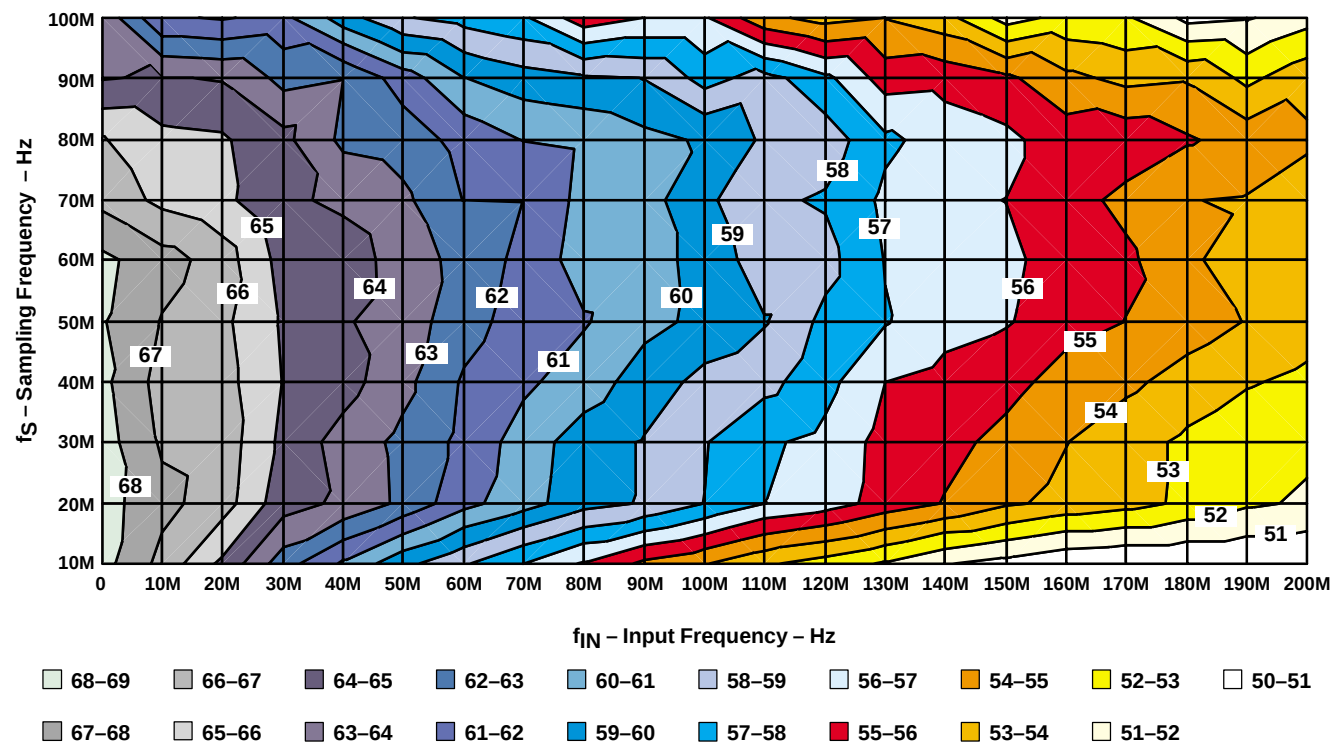


Figure 8. SINAD [dBFS]

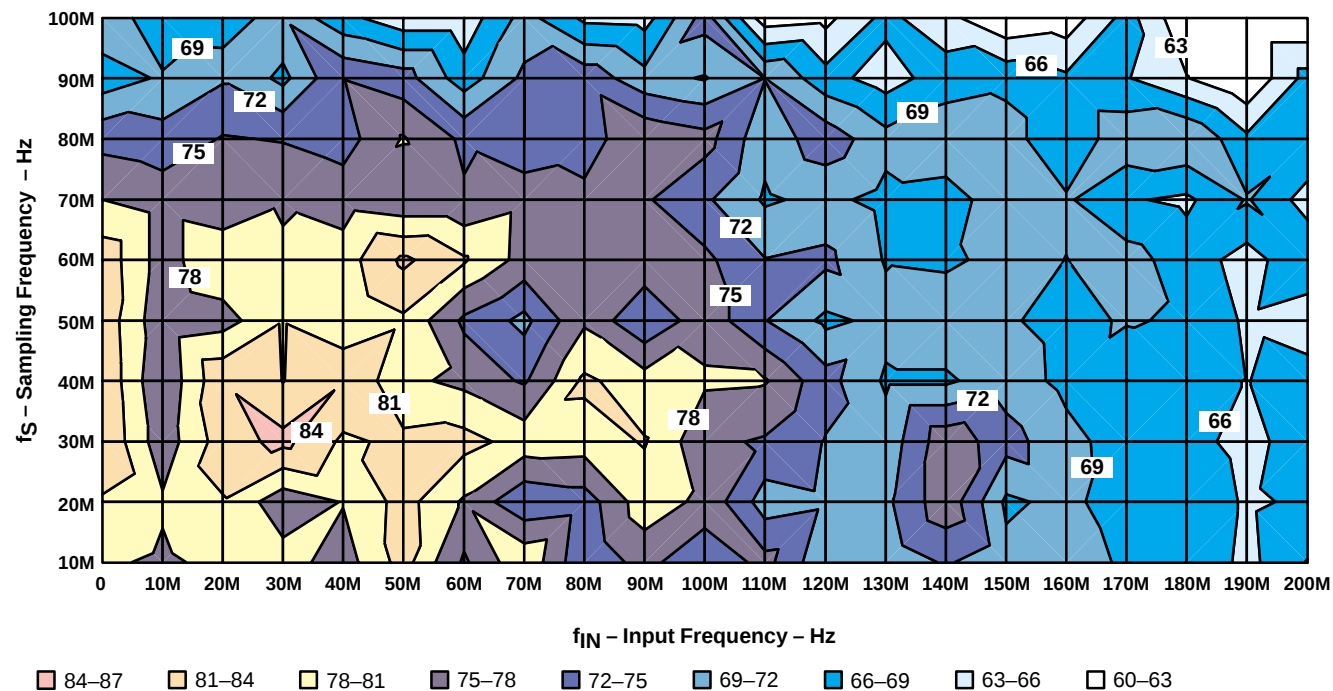


Figure 9. SFDR [dBc]

†50% duty cycle. $AV_{DD} = 3.3$ V, $DV_{DD} = 1.8$ V, $DV_{DD} = 1.8$ V

TYPICAL CHARACTERISTICS†

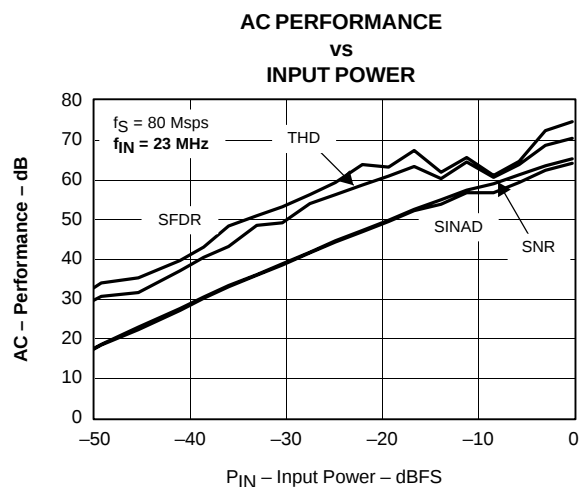


Figure 10

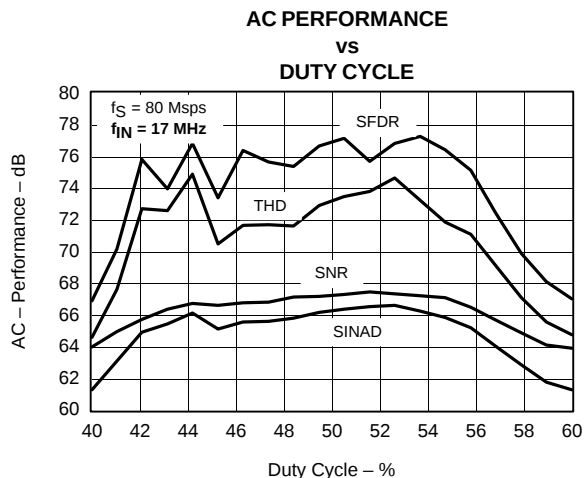
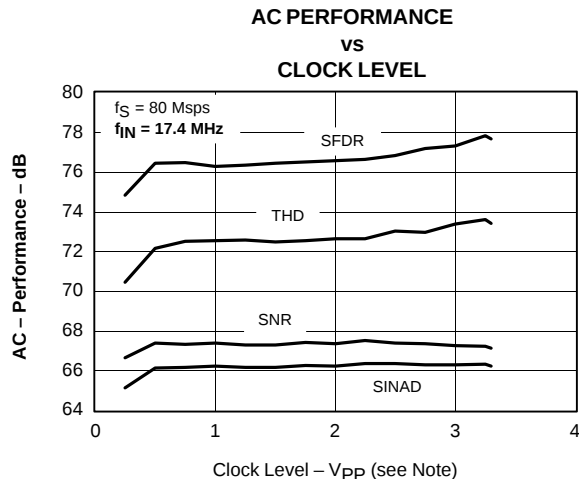


Figure 11



NOTE: Voltage peak to peak in pin 19 or 20. Multiply by 2 to obtain differential peak to peak.

Figure 12

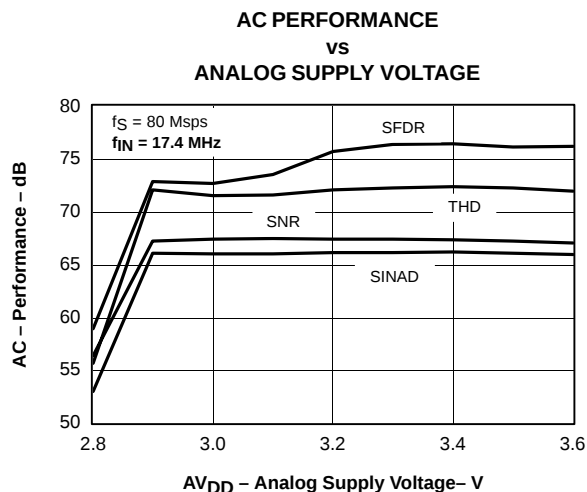


Figure 13

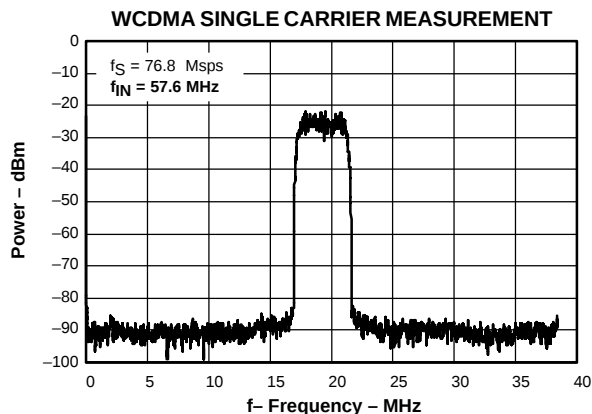


Figure 14

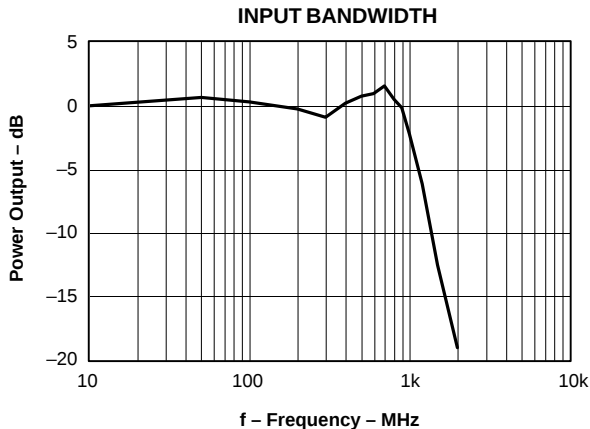


Figure 15

†50% duty cycle. $AV_{DD} = 3.3$ V, $DV_{DD} = 1.8$ V, $DV_{DD} = 1.8$ V

TYPICAL CHARACTERISTICS†

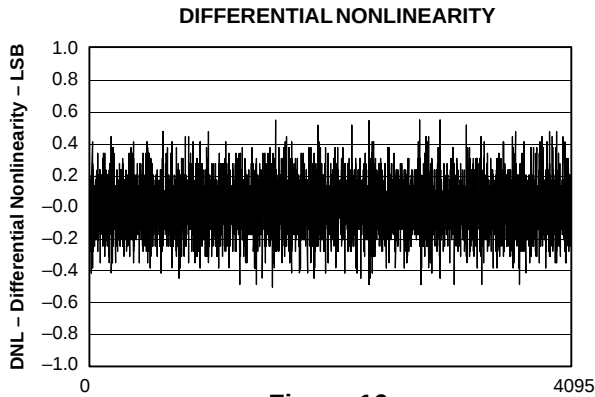


Figure 16

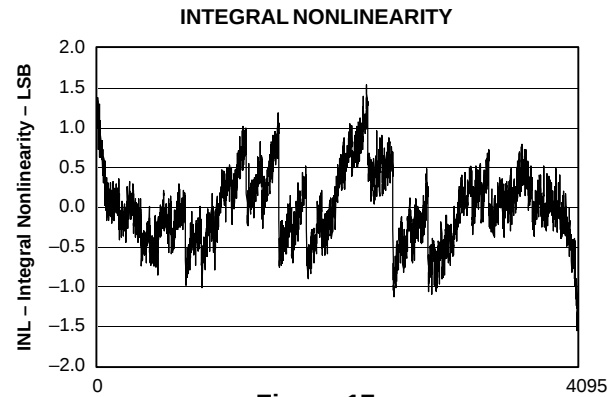


Figure 17

†50% duty cycle. $AV_{DD} = 3.3\text{ V}$, $DV_{DD} = 1.8\text{ V}$, $DV_{DD} = 1.8\text{ V}$

EQUIVALENT CIRCUITS

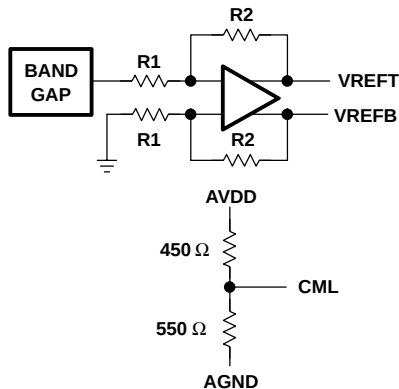


Figure 18. References

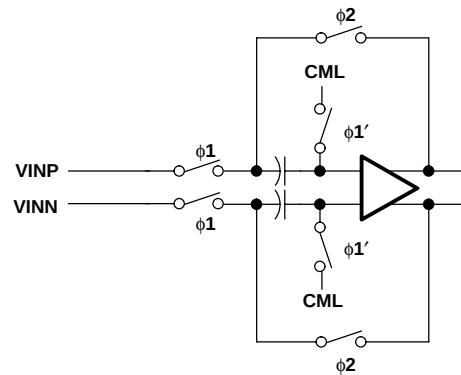


Figure 19. Analog Input Stage

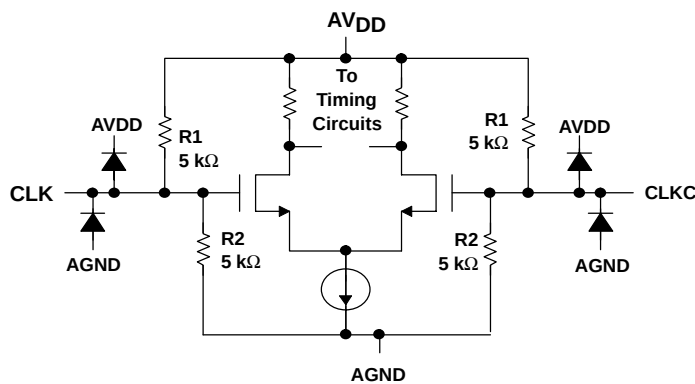


Figure 20. Clock Inputs

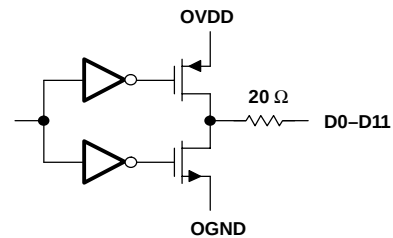


Figure 21. Digital Outputs

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Another possibility is the use of differential input/output amplifiers that can simplify the driver circuit for applications requiring input dc coupling. Flexible in their configurations (Figure 24), such amplifiers can be used for single ended to differential conversion, for signal amplification, and also for filtering prior to the ADC.

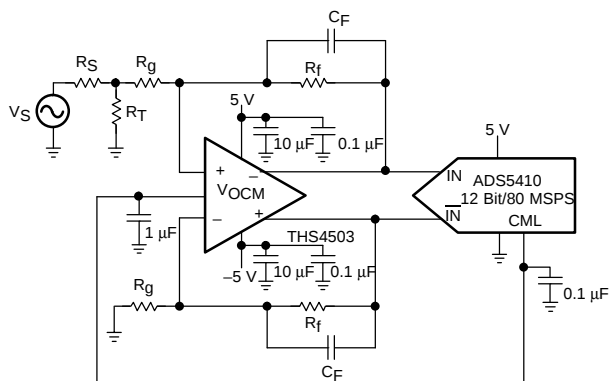


Figure 24. Using the THS4503 With the ADS5410

REFERENCE CIRCUIT

The ADS5410 has its own internal reference generation saving external circuitry in the design. For optimum performance, it is best to connect both VREFB and VREFT to ground with a 1-µF and 0.1-µF decoupling capacitors in parallel, and a 0.1-µF capacitor between both pins (Figure 25). The band-gap voltage output is not a voltage source, and is used internally by the ADS5410. However, it should be decoupled to ground with a 1-µF and 0.01-µF capacitor, in parallel.

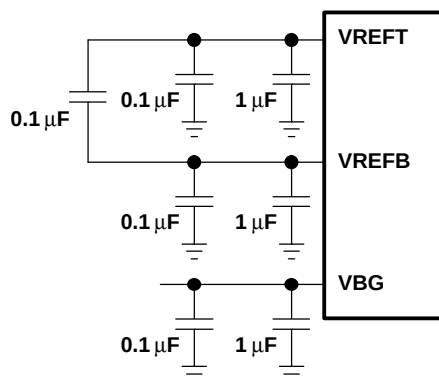


Figure 25. Internal Reference Usage

CLOCK INPUTS

The ADS5410 clock input can be driven with either a differential clock signal or a single ended clock input with little or no difference in performance between the single-ended and differential-input configurations. The common mode of the clock inputs is set internally to $AV_{DD}/2$ using 5-kΩ resistors (Figure 20). The clock input should be either a sine wave or a square wave having a 50% duty cycle.

When driven with a single-ended CMOS clock input, it is best to connect the CLK input to ground with a 0.01-µF capacitor (see Figure 26) while CLK is ac couple with 0.01 µF to the clock source.

The ADS5410 clock input can also be driven differentially, reducing susceptibility to common mode noise. In this case, it is best to connect both clock inputs to the differential input clock signal with 0.01-µF capacitors (see Figure 27). The differential input swing can vary between 1 V and 6 V with little or no performance degradation (see Figure 12).

POWER DOWN

When power down (pin 16) is tight to AV_{DD} , the device reduces its power consumption until a typical value of 30 mW. Connecting this pin to GND enables the device operation.

DIGITAL OUTPUTS

The ADS5410 output format is 2s complement. The voltage level of the outputs can be adjusted by setting the OVDD voltage between 1.65 V and 3.6 V, allowing for direct interface to several digital families. For better performance, customers should select the smaller output swing required in the application. To improve the performance, mainly on the higher output voltage swing configurations, the addition of a series resistor at the outputs, limiting peak currents, is recommended. The maximum value of this resistor is limited by the maximum data rate of the application. Values between 0 Ω and 200 Ω are usual. Also, limiting the length of the external traces is a good practice.

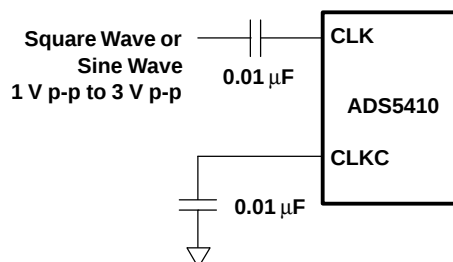


Figure 26. AC-Coupled Single-Ended Clock Input

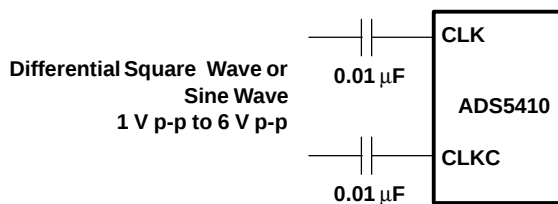


Figure 27. AC-Coupled Differential Clock Input

DEFINITION OF SPECIFICATIONS

Analog Bandwidth

The analog input frequency at which the spectral power of the fundamental frequency (as determined by the FFT analysis) is reduced by 3 dB.

Aperture Delay

The delay between the 50% point of the rising edge of the CLK command and the instant at which the analog input is sampled.

Aperture Uncertainty (Jitter)

The sample-to-sample variation in aperture delay.

Differential Nonlinearity

The average deviation of any single LSB transition at the digital output from an ideal 1 LSB step at the analog input.

Integral Nonlinearity

The deviation of the transfer function from a reference line measured in fractions of 1 LSB using a *best straight line* determined by a least square curve fit.

Clock Pulse Width/Duty Cycle

Pulse width high is the minimum amount of time that the CLK pulse should be left in logic 1 state to achieve rated performance; pulse width low is the minimum time CLK pulse should be left in low state. At a given clock rate, these specs define an acceptable clock duty cycles.

Maximum Conversion Rate

The clock rate at which parametric testing is performed.

Offset Error

The difference between the voltage at which the digital output transitions from midscale to one LSB above midscale, and the ideal voltage at which this transition should occur

Output Propagation Delay ($t_{d2(O)}$)

The delay between the 50% point of the rising edge of CLK command and the time when all output data bits are within valid logic levels.

Power Supply Rejection Ratio

The ratio of a change in input offset voltage to a change in power supply voltage.

Signal-to-Noise and Distortion (SINAD)

The ratio of the rms signal amplitude (set 1 dB below full scale) to rms value of the sum of all other spectral components, including harmonics but excluding dc.

Signal-to-Noise Ratio (Without Harmonics)

The ratio of the rms signal amplitude (set at 1 dB below full scale) to the rms value of the the sum of all other spectral components, excluding the first five harmonics and dc.

Spurious-Free Dynamic Range

The ratio of the rms signal amplitude to the rms value of the peak spurious spectral component. The peak spurious component may or may not be a harmonic and it is reported in dBc.

Two-Tone Intermodulation Distortion Rejection

The ratio of the rms value of either input tone to the rms value of the worst third order intermodulation product reported in dBc

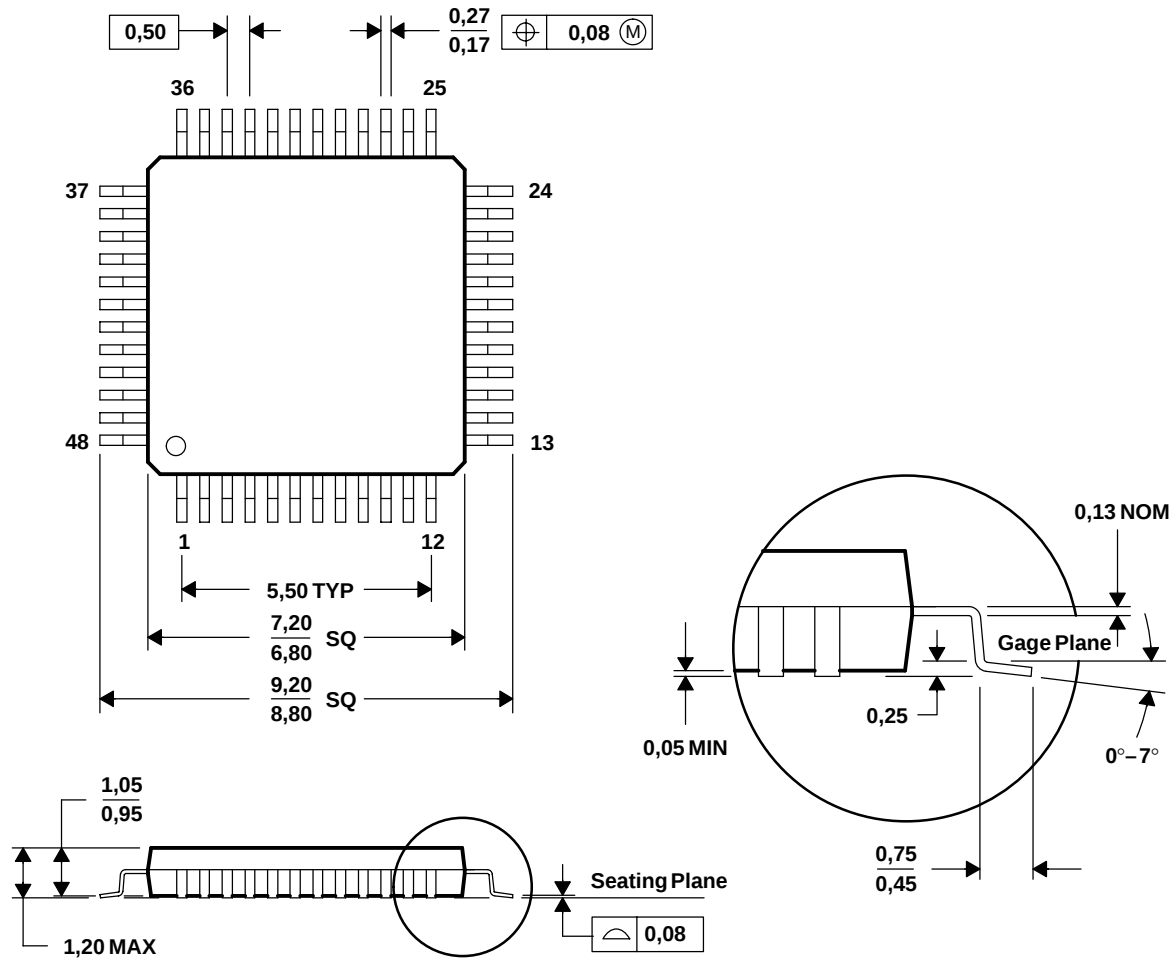
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MECHANICAL DATA

PFB (S-PQFP-G48)

PLASTIC QUAD FLATPACK



4073176/B 10/96

- NOTES: A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Falls within JEDEC MS-026

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